



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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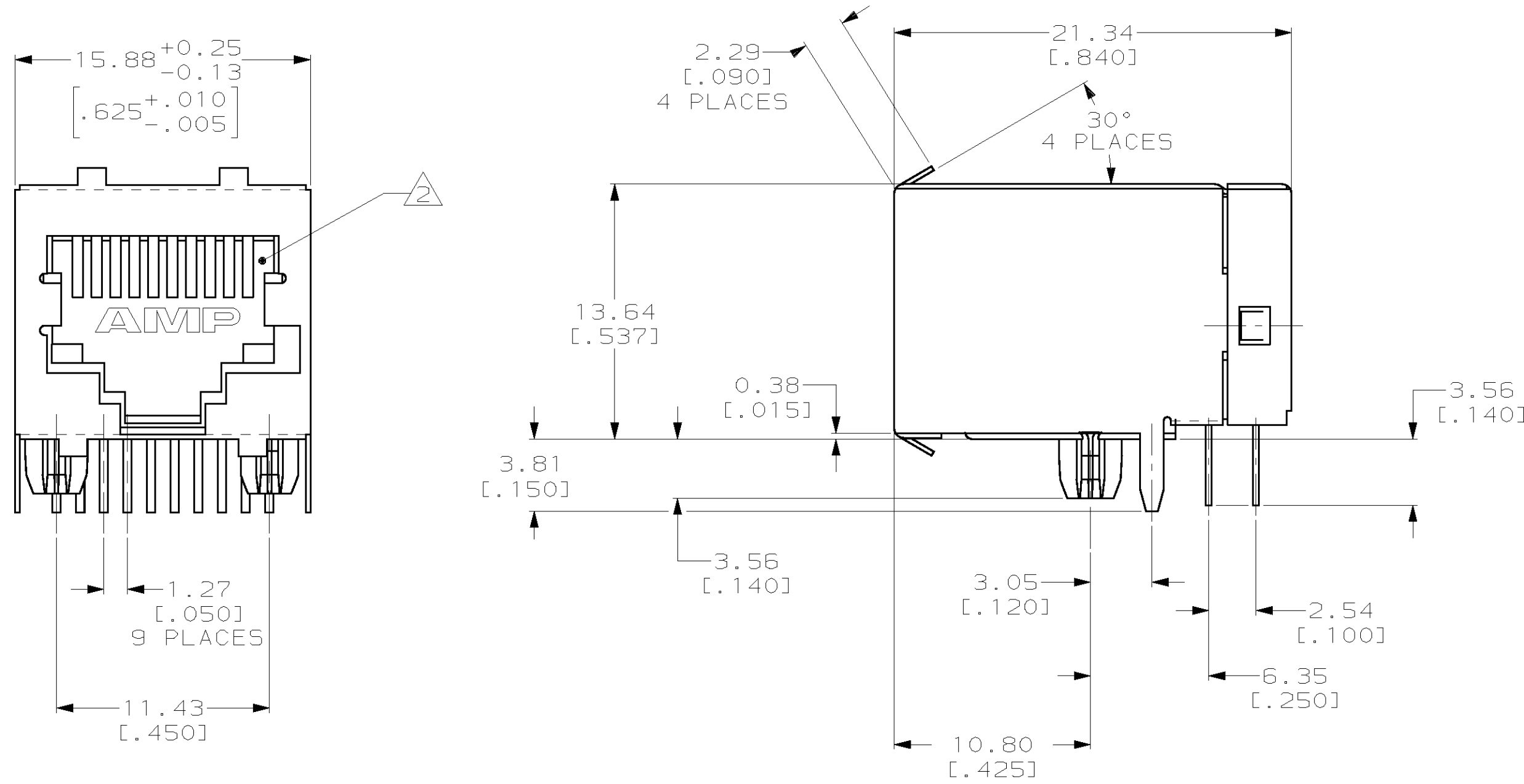
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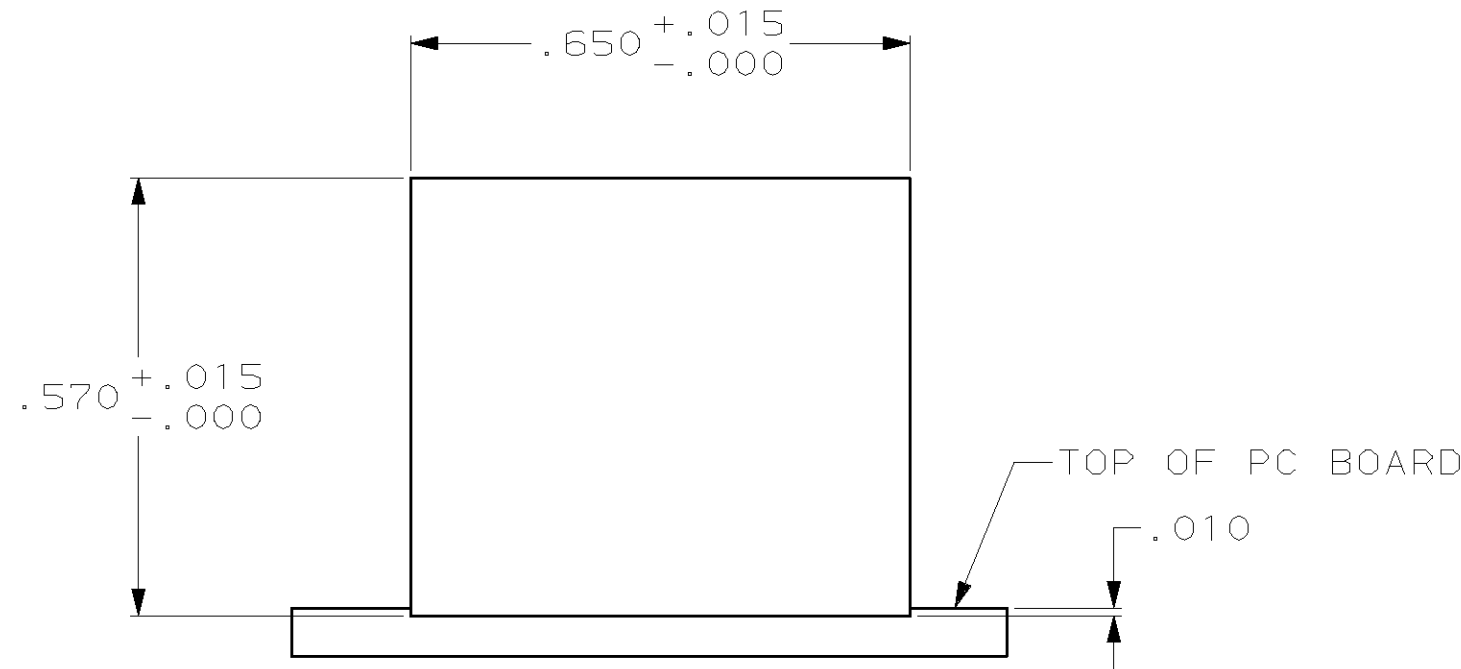
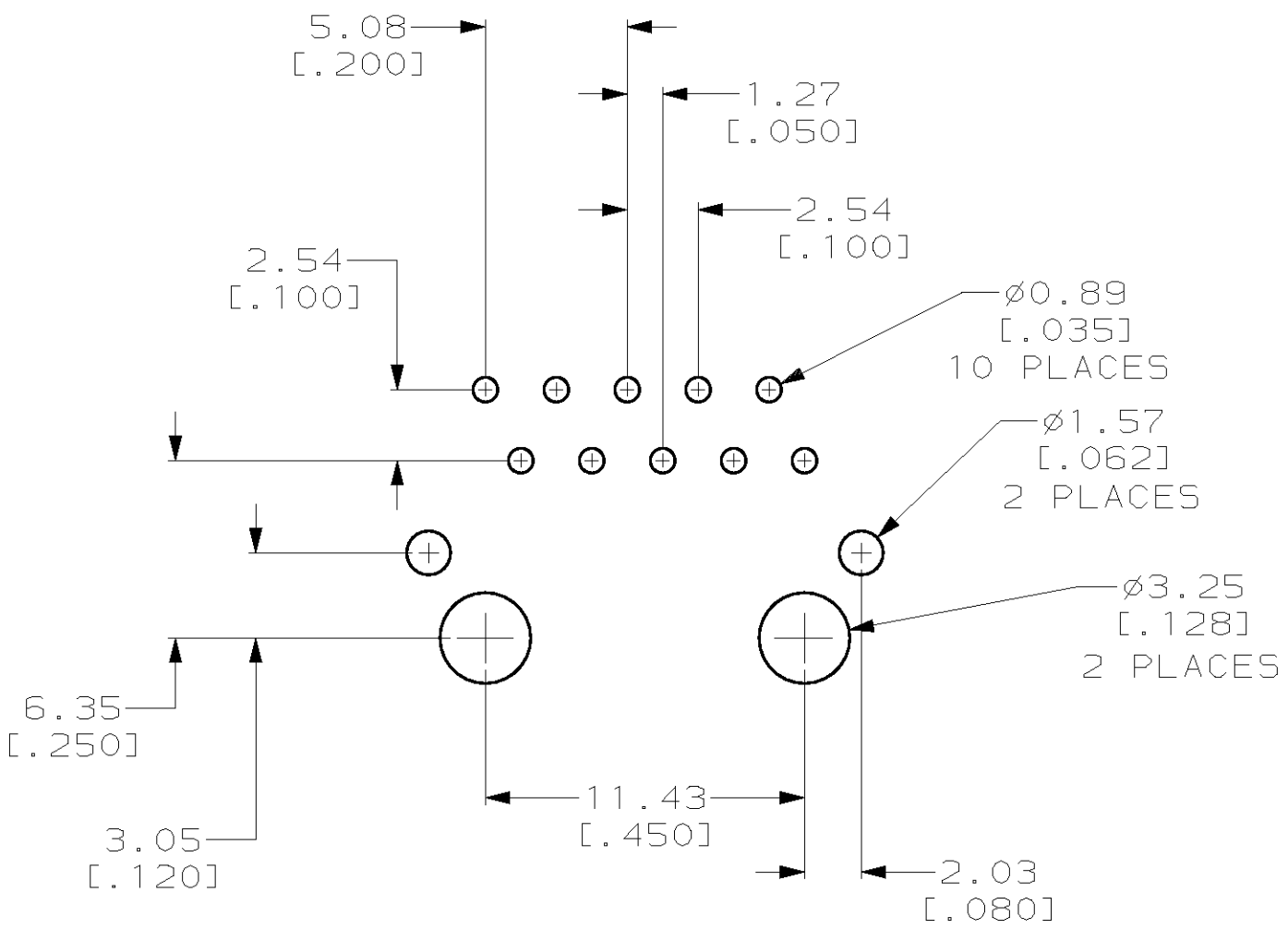
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LOC	DIST	REVISIONS					
AA	22	P	LTR	DESCRIPTION	DATE	DWN	APVD
			B	REV; EC 067A-0191-98	29JAN99	DLD	CMB




- 1 MATERIALS:
HOUSING - PCT POLYESTER, BLACK, IR
REFLOW COMPATIBLE, UL 94V-0.
TERMINALS 0.33 [0.013] THICK PH05
BRONZE PLATED WITH 1.27µm [0.000050]
HARD GOLD IN LOCALIZED AREA AND 3.81µm
[0.000150] THICK TIN-LEAD IN SOLDER
AREA OVER 1.27µm [0.000050] MINIMUM
THICK NICKEL UNDERPLATE.
SHIELD - 0.25 [0.010] THICK COPPER ALLOY
PLATED WITH 2.03µm [0.000080] MINIMUM
TIN-LEAD OVER 2.54µm [0.000100] MINIMUM
COPPER.
- 2 JACK CAVITY CONFORMS TO FCC RULES AND
REGULATIONS,PART 68 SUBPART F.
3. DIMENSIONS ARE NOMINAL UNLESS OTHER-
WISE SPECIFIED.



SUGGESTED PANEL CUTOUT

SUGGESTED PC BOARD LAYOUT
VIEW SHOWN IS TOP (COMPONENT SIDE) OF PC BOARD

558070-1
PART NUMBER

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		CHK B. FOX 03-AUG-93			
DIMENSIONS: mm [INCHES]	TOLERANCES UNLESS OTHERWISE SPECIFIED:	APVD G. REED 03-AUG-93	NAME MODULAR JACK ASSEMBLY, 10 POSITION SIDE ENTRY, LOW PROFILE, FULLY SHIELDED, PANEL GROUND		
	0 PLC ±-	PRODUCT SPEC 108-1163	SIZE A2		
	1 PLC ±-	APPLICATION SPEC 114-2048			CAGE CODE 00779
	MATERIAL	2 PLC ±0.25 [0.01]	WEIGHT -	DRAWING NO C-558070	
		3 PLC ±0.13 [0.005]			
	4 PLC ±-		SCALE 4:1		
	ANGLES ±-		SHEET 1 OF 1	REV B	
		CUSTOMER DRAWING			

558070